

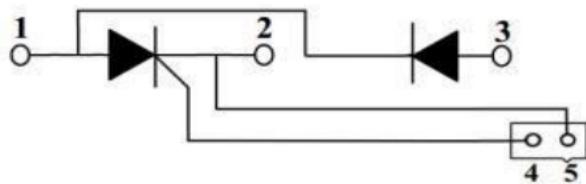


PRODUCT FEATURES

- Heat transfer through aluminium nitride ceramic isolated metal baseplate
- High Surge Current Capability
- Low Inductance Package

APPLICATIONS

- DC Motor Control and Drives
- Battery Charges ,Heater controls,Light dimmers
- Temperature control



ABSOLUTE MAXIMUM RATINGS

$T_C = 25^\circ\text{C}$ unless otherwise specified

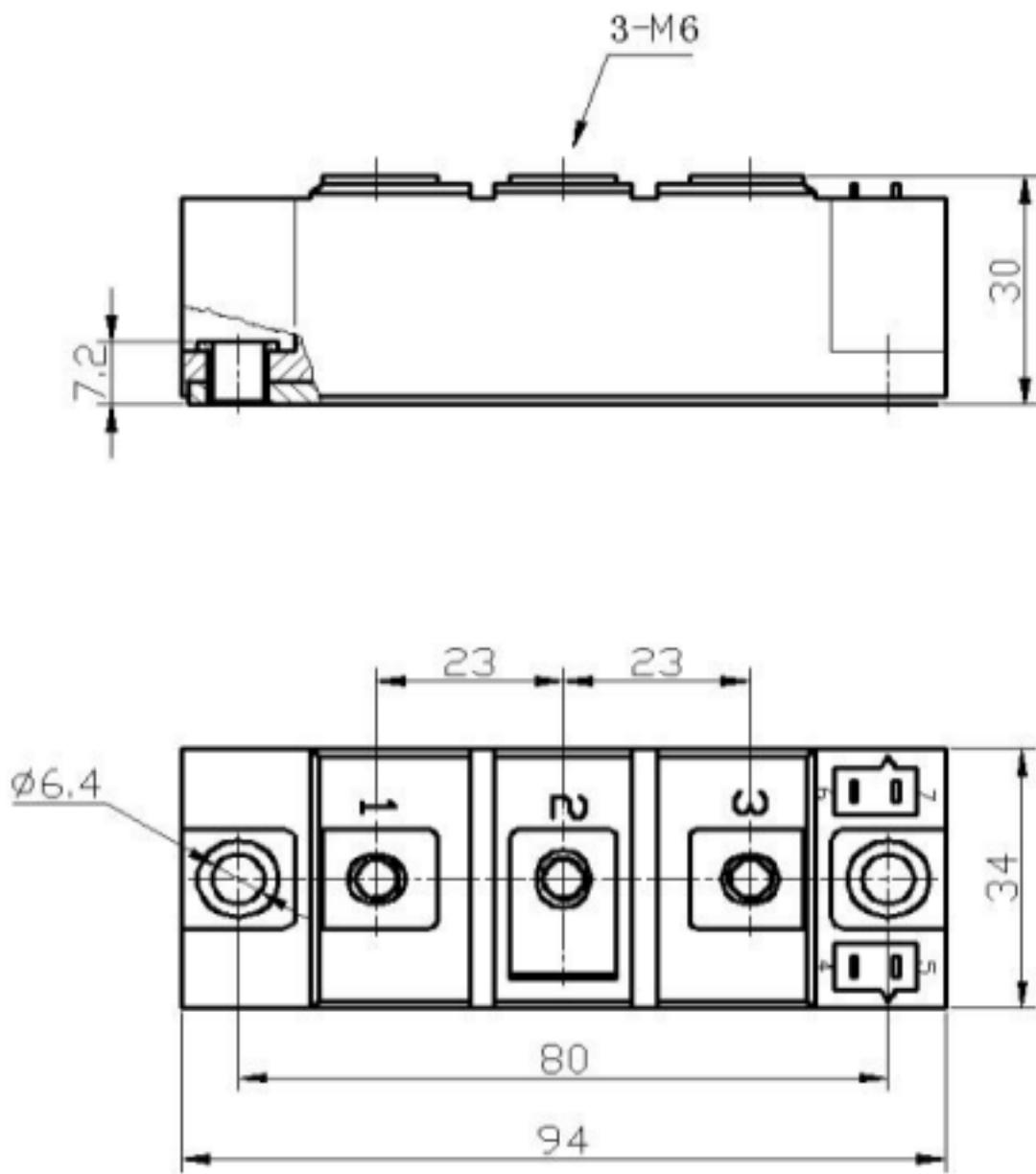
Symbol	Parameter/Test Conditions	Values	Unit
		EK200M42-160UA	
V_{RRM}	Repetitive Peak Reverse Voltage	1600	V
V_{DRM}	Repetitive Peak Off State Voltage	1600	
V_{RSM}	Non-Repetitive Peak Reverse Voltage	1700	

Symbol	Parameter/Test Conditions		Values	Unit
$I_{T(AV)}$	Average On State Current	Single phase, half wave, 180° conduction, $T_c = 85^\circ\text{C}$	200	A
$I_{T(RMS)}$	R.M.S. On State Current	Single phase, half wave, 180° conduction, $T_c = 85^\circ\text{C}$	314	
I_{TSM}	Non Repetitive Surge On State Current	$t = 10\text{ms}, 50\text{Hz}, T_{jm}$	5800	
I^2t	For Fusing	$V_r = 0.6V_{rrm}, T_{jm}$	168.2	KA^2s
T_J	Junction Temperature		-40 to +125	°C
T_{STG}	Storage Temperature Range		-40 to +125	°C
V_{ISO}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), $t=1\text{minute}$	3000	V
Torque	Module to Sink	Recommended (M6)	4~6	Nm
Torque	Module Electrodes	Recommended (M6)	4~6	Nm
R_{thJC}	Junction to Case Thermal Resistance		0.21	K/W
Weight			220	g

ELECTRICAL CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
I_{DRM}	Maximum Peak Off-State Current $V_D = V_{DRM}, T_J = 125^\circ\text{C}$			30	mA
I_{RRM}	Maximum Peak Reverse Current $V_R = V_{RRM}, T_J = 125^\circ\text{C}$			30	
V_{TM}	Thyristor: on-state peak volt $I_{TM} = 60\text{A}, T = 25^\circ\text{C}$			1.7	V
V_{FM}	Diode: Peak forward voltage IFM=600A, $T_J = 25^\circ\text{C}$			1.2	V
V_{GT}	Max. required DC gate voltage to trigger $V_A = 12\text{V}, R_A = 1\Omega$			0.7-1.8	V
I_{GT}	Max. required DC gate current to trigger $V_A = 12\text{V}, R_A = 1\Omega$			20-150	mA
V_{GD}	Max. required DC gate voltage not to trigger, $V_D = V_{DRM}, T_J = 125^\circ\text{C}$			0.25	V
I_{GD}	Max. required DC gate current not to trigger, $V_D = V_{DRM}, T_J = 125^\circ\text{C}$			10	mA
I_H	Maximum holding current			20-150	mA
I_L	Maximum latching current			100-400	mA
dv/dt	Critical Rate of Rise of Off-State Voltage, $T_J = 125^\circ\text{C}$, exponential to 67% rated V_{DRM}			500	V/ μs
di/dt	$V_D = 2/3V_{DRM}, I_{GM} = 1.5\text{A}, \text{dig}/dt = 0.3\text{A}/\mu\text{s}, T_J = 25^\circ\text{C}$			150	A/ μs



Dimensions in (mm)
Package Outline